

Advanced Power MOSFET

unit: mm

SWITCHING REGULATOR APPLICATIONS

Features

• High Voltage: BV_{DSS}=600V(Min.)

• Low C_{rss} : $C_{rss}=4pF(Typ.)$

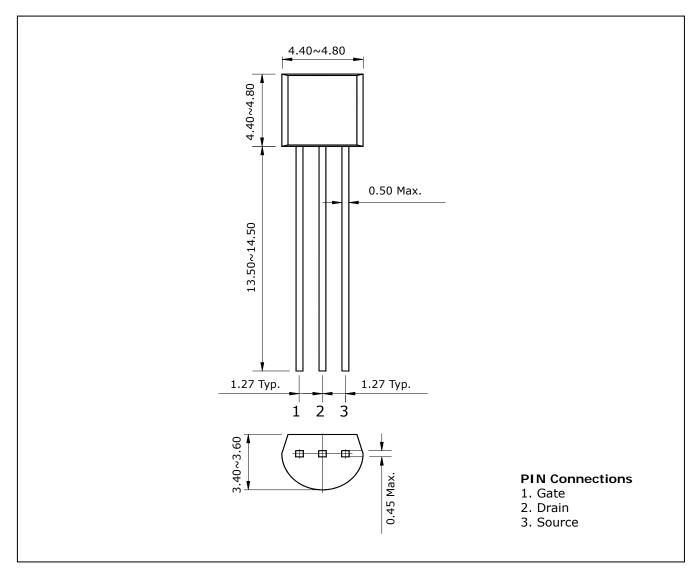
• Low gate charge : Qg=12nC(Typ.)

• Low $R_{DS(on)}$: $R_{DS(on)}$ =5.5 Ω (Typ.)

Ordering Information

Type NO.	Marking	Package Code	
STK03Y60	STK03Y60	TO-92	

Outline Dimensions



Absolute maximum ratings

(Ta=25°C)

Characteristic	Symbol	Rating	Unit
Drain-source voltage	V_{DSS}	600	V
Gate-source voltage	V_{GSS}	±30	V
Drain current (DC) **	I_{D}	0.3	Α
Drain current (Pulsed) *	I_{DP}	1.2	Α
Total Power dissipation **	P _D	625	mW
Avalanche current (Single)	I _{AS}	0.3	Α
Single pulsed avalanche energy	E _{AS}	53	mJ
Avalanche current (Repetitive)	I _{AR}	0.3	Α
Repetitive avalanche energy	E _{AR}	11	mJ
Junction temperature	T _J	150	°C
Storage temperature range	T _{stg}	-55~150	C

^{*} Limited by maximum junction temperature

^{**} Device mounted on a glass-epoxy board

Characteristic		Symbol	Тур.	Max	Unit
Thermal resistance	Junction-ambient	$R_{th(\mathtt{J-a})}^{}**}$	-	200	°C/W

N-CH Electrical Characteristics

(Ta=25°C)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Drain-source breakdown voltage	BV_{DSS}	$I_D = 250 \mu A, V_{GS} = 0$	600	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$I_D=250\mu A$, $V_{DS}=V_{GS}$	3.0	-	5.0	V
Drain-source cut-off current	I_{DSS}	V _{DS} =600V, V _{GS} =0V	-	-	1	μΑ
Gate leakage current	I_{GSS}	V_{DS} =0V, V_{GS} =±30V	-	-	±100	nA
Drain-source on-resistance	R _{DS(ON)}	V _{GS} =10V, I _D =150mA	-	5.5	8.5	Ω
Forward transfer conductance 4	g_{fs}	V _{DS} =10V, I _D =150mA	-	0.32	-	S
Input capacitance	Ciss	V _{GS} =0V, V _{DS} =25V,	-	130	_	
Output capacitance	Coss	f=1MHz	-	20	-	pF
Reverse transfer capacitance	Crss		-	4	-	
Turn-on delay time	t _{d(on)}		-	5.5	-	
Rise time	t _r	$V_{DD} = 300V, I_{D} = 0.3A$	-	5	-	no
Turn-off delay time	$t_{d(off)}$	$R_G = 25\Omega$ 34	-	13	-	ns
Fall time	t _f		-	28	-	
Total gate charge	Q_g	V _{DD} =300V, V _{GS} =10V	-	12	18	
Gate-source charge	Q_{gs}	$I_D=0.3A$	-	2.5	3.8	nC
Gate-drain charge	Q_{gd}	34	-	3.0	4.5	

Source-Drain Diode Ratings and Characteristics

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Characteristic	Symbol	Test Condition	Min	Тур	Max	Unit
Source current	I_S	Integral reverse diode	-	-	0.3	_
Source current(Plused)	I_{SM}	in the MOSFET	-	-	1.2	Α
Forward voltage (4	V_{SD}	V_{GS} =0V, I_{S} =0.3A	-	0.7	1.2	V
Reverse recovery time	t _{rr}	I _s =0.3A, V _{gs} =0V	-	260	-	ns
Reverse recovery charge	Q_{rr}	di _S /dt=80A/us	_	3.5	_	uC

Note;

① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature

② L=109mH, I_{AS} =0.3A, V_{DD} =50V, R_{G} =25 Ω

③ Pulse Test : Pulse Width < 300us, Duty cycle ≤ 2%

4 Essentially independent of operating temperature

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